IRF530

Vishay Siliconix



TO-220AB

PRODUCT SUMMARY

V_{DS} (V)

R_{DS(on)} (Ω)

Q_{gs} (nC)

Q_{gd} (nC)

Q_a max. (nC)

Configuration

Power MOSFET

S

N-Channel MOSFET

0.16

100

26

5.5

11

Single

 $V_{GS} = 10 V$

FEATURES

- Dynamic dV/dt rating
- · Repetitive avalanche rated
- 175 °C operating temperature
- Fast switching
- Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRF530PbF
Lead (Pb)-free and halogen-free	IRF530PbF-BE3

ABSOLUTE MAXIMUM RATINGS ($T_c = 25 \degree C$, unless otherwise noted)									
PARAMETER			SYMBOL	LIMIT	UNIT				
Drain-source voltage			V _{DS}	100	Ň				
Gate-source voltage			V _{GS}	± 20	V				
Continuous drain current	V _{GS} at 10 V	T _C = 25 °C		14					
		T _C = 100 °C	I _D	10	А				
Pulsed drain current ^a			I _{DM}	56	1				
Linear derating factor				0.59	W/°C				
Single pulse avalanche energy ^b			E _{AS}	69	mJ				
Repetitive avalanche current ^a			I _{AR}	14	А				
Repetitive avalanche energy ^a			E _{AR}	8.8	mJ				
Maximum power dissipation	T _C =	25 °C	PD	88	W				
Peak diode recovery dV/dt ^c			dV/dt	5.5	V/ns				
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +175	°C				
Soldering recommendations (peak temperature) ^d	For 10 s			300					
Mounting torque	6-32 or M3 screw			10	lbf ∙ in				
			-	1.1	N · m				

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. V_{DD} = 25 V, starting T_J = 25 °C, L = 528 µH, R_g = 25 Ω , I_{AS} = 14 A (see fig. 12)

c. $I_{SD} \le 14$ A, dI/dt ≤ 140 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 175$ °C

d. 1.6 mm from case

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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	-		62				
Case-to-sink, flat, greased surface	R _{thCS}	0.50 -				°C/W		
Maximum junction-to-case (drain)	R _{thJC}	- 1.7						
	•							
SPECIFICATIONS (T _J = 25 °C, u	nless otherw	ise noted)						
PARAMETER	SYMBOL	TEST	CONDITI	ONS	MIN.	TYP.	MAX.	UNIT
Static						•	•	
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0$	V, I _D = 2	50 µA	100	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference t	o 25 °C, l	l _D = 1 mA	-	0.12	-	V/°C
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{0}$	_{GS} , I _D = 2	50 µA	2.0	-	4.0	V
Gate-source leakage	I _{GSS}	V _G	V _{GS} = ± 20 V			-	± 100	nA
Zero gate voltage drain current		V _{DS} = 100 V, V _{GS} = 0 V			-	-	25	
	I _{DSS}	V _{DS} = 80 V, V ₀	_{GS} = 0 V, '	T _J = 150 °C	-	-	250	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D	= 8.4 A ^b	-	-	0.16	Ω
Forward transconductance	g _{fs}	V _{DS} = 50	0 V, I _D = 8	8.4 A ^b	5.1	-	-	S
Dynamic						•	•	
Input capacitance	C _{iss}	V	a = 0 V		-	670	-	
Output capacitance	C _{oss}	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5		-	250	-	pF	
Reverse transfer capacitance	C _{rss}			-	60	-		
Total gate charge	Qg				-	-	26	nC
Gate-source charge	Q_gs	$V_{GS} = 10 V$		_D = 14 A, V _{DS} = 80 V, see fig. 6 and 13 ^b	-	-	5.5	
Gate-drain charge	Q _{gd}				-	-	11	
Turn-on delay time	t _{d(on)}				-	10	-	
Rise time	t _r	V_{DD} = 50 V, I_D = 14 A R_g = 12 Ω,R_D = 3.6 Ω,see fig. 10 $^{\rm b}$		-	34	-	ns	
Turn-off delay time	t _{d(off)}			-	23	-		
Fall time	t _f				-	24	-	1
Gate input resistance	R _g	f = 1 MHz, open drain			1.0	-	4.7	Ω
Internal drain inductance	L _D	6 mm (0.25") fr	Between lead, 6 mm (0.25") from		-	4.5	-	
Internal source inductance	Ls	die contact		-	7.5	-	nH	
Drain-Source Body Diode Characteristic	cs					•	•	1
Continuous source-drain diode current	I _S	MOSFET symbol showing the		-	-	14	A	
Pulsed diode forward current ^a	I _{SM}	p - n junction diode			-	-		56
Body diode voltage	V _{SD}	$T_{\rm J}$ = 25 °C, $I_{\rm S}$ = 14 A, $V_{\rm GS}$ = 0 V ^b			-	-	2.5	V
Body diode reverse recovery time	t _{rr}	$T_J = 25 \text{ °C}, I_F = 14 \text{ A}, dl/dt = 100 \text{ A/}\mu\text{s}^{b}$ Intrinsic turn-on time is negligible (turn			-	150	280	ns
Body diode reverse recovery charge	Q _{rr}				-	0.85	1.7	μC
Forward turn-on time	t _{on}				on is do	minated b	by L _S and	and L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 µs; duty cycle \leq 2 %

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

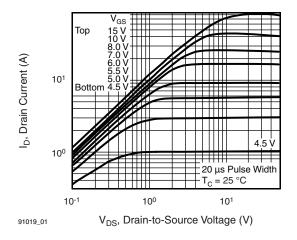


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

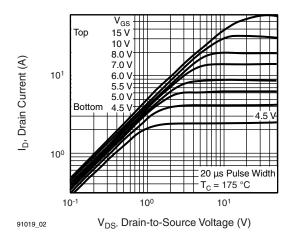
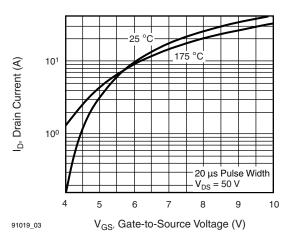


Fig. 2 - Typical Output Characteristics, $T_C = 175 \ ^{\circ}C$





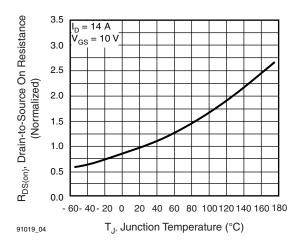


Fig. 4 - Normalized On-Resistance vs. Temperature

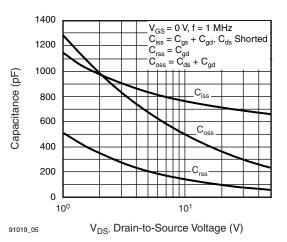


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

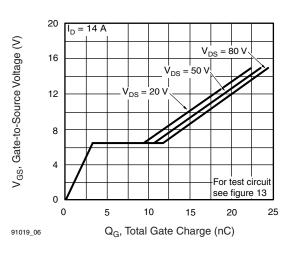


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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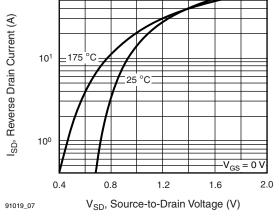


Fig. 7 - Typical Source-Drain Diode Forward Voltage

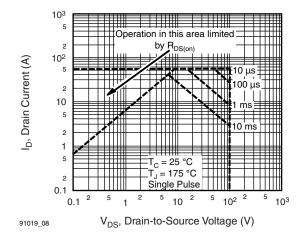


Fig. 8 - Maximum Safe Operating Area

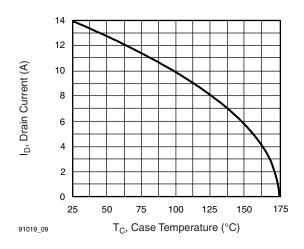


Fig. 9 - Maximum Drain Current vs. Case Temperature

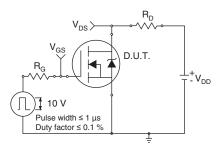


Fig. 10a - Switching Time Test Circuit

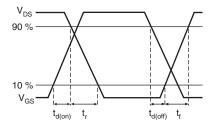


Fig. 10b - Switching Time Waveforms

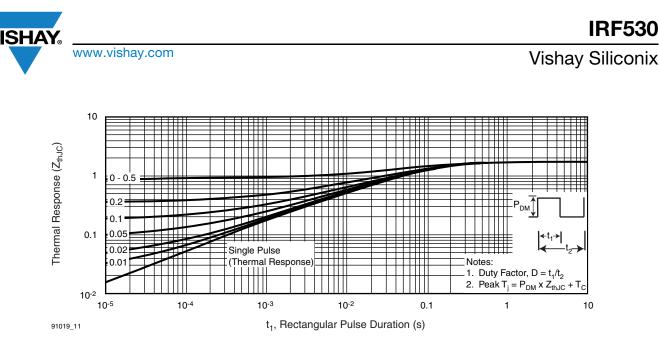


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

V_{DS}

I_{AS}

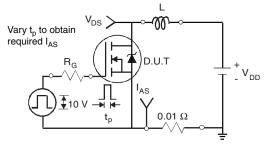


Fig. 12a - Unclamped Inductive Test Circuit

Fig. 12b - Unclamped Inductive Waveforms

/_{DS}

 V_{DD}

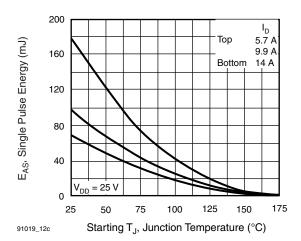


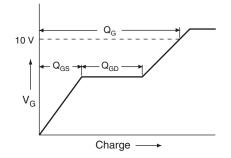
Fig. 12c - Maximum Avalanche Energy vs. Drain Current

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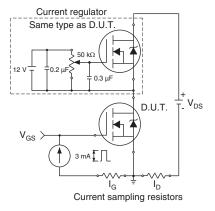


Fig. 13a - Basic Gate Charge Waveform



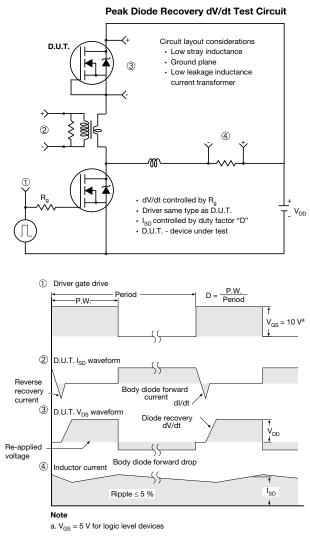


Fig. 14 - For N-Channel

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